COMPONENT SPECIFICATION

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Name | Wirewound Common Mode Filter | COMPONENT SPECIFICATION | 1/9

1. SCOPE

This specification applies to the EOWS-2012 series SMD WirewoundCommon Mode Filter.

2. STANDARD ATMOSPHERIC CONDITIONS

Unless otherwise specified the standard range of atmospheric conditions for making measurements and tests is as follows:

Ambient temperature : 20±15°C Relative humidity : 65±20%

If there may be any doubt on the results, measurements shall be made within

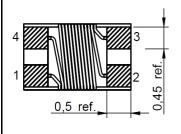
the following limits:

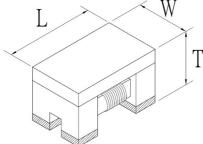
Ambient temperature : $25\pm5^{\circ}$ C Relative humidity : $75\pm10\%$

3. RATINGS

	IMPEDANCE (Ω)	DC RESISTANCE	RATED	RATED	INSULATION	INSULATION
PART NO.			CURRENT	VOLTAGE	RESISTANCE	TEST VOLTAGE
	AT100MHz / 500mV	(Ω) MAX	(mA) MAX	(V)	(MΩ) MIN	(V)(AC) MAX
EOWS201212M900	90±25%	0.35	330	50	10	125

4. DIMENSION





unit: mm (inch) OPERATING TEMP. RANGE: -40° C $\sim +125^{\circ}$ C STORAGE TEMP. RANGE: -40° C $\sim +85^{\circ}$ C

 TYPE
 L
 W
 T

 EOWS-2012
 2.00±0.20
 1.20±0.20
 1.20±0.20

 (.080±.008)
 (.048±.008)
 (.048±.008)

5. The place of origin:

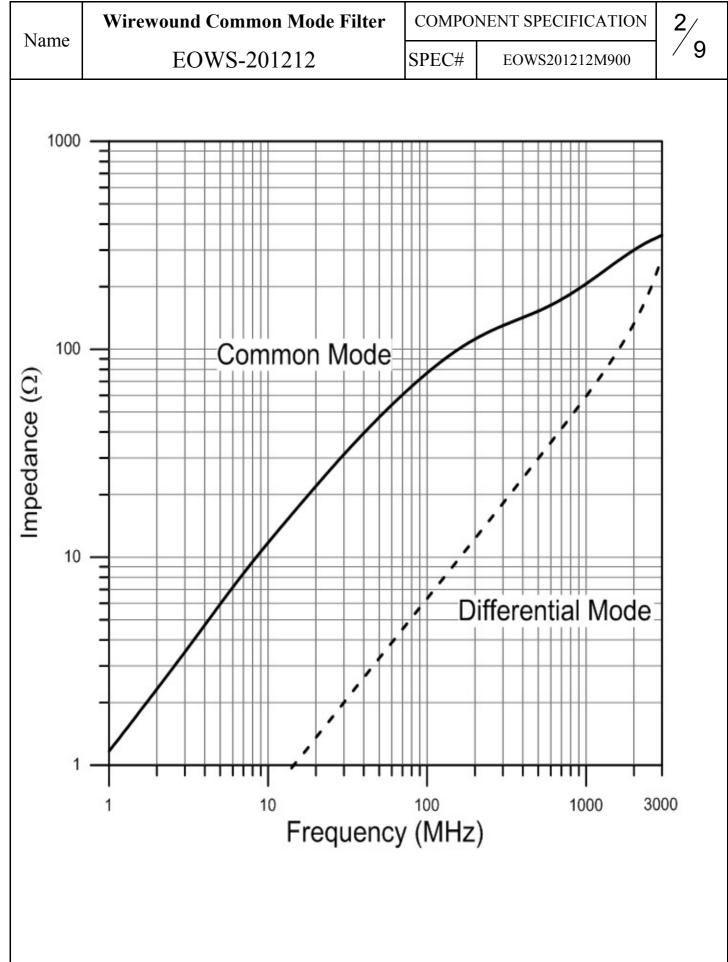
Taichung, Taiwan

PLANNED BY	CHECKED BY	APPROVED BY	
Marco	LUN	Tina Hsu	鈺鎧文件中心 發行章

表格編號:034承認書 A 2021/1/19

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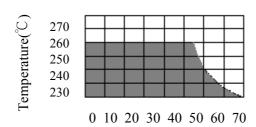
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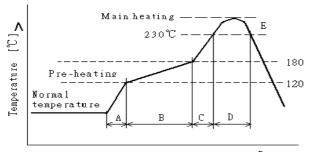
Wirewound Common Mode Filter COMPONENT SPECIFICATION Name EOWS-201212 SPEC# EOWS201212M900

Reflow soldering conditions

- Pre—heating should be in such a way that the temperature difference between solder and ceramic surface is limited to 150°C max. Also cooling into solvent after soldering should be in such a way that the temperature difference is limited to 100°C max.
 - Insufficient pre—heating may cause cracks on the ceramic, resulting in the deterioration of product quality.
- Products should be soldered within the following allowable range indicated by the slanted line. The excessive soldering conditions may cause the corrosion of the electrode, when soldering is repeated, allowable time is the accumulated time.



Temperature Profile



Α	Slope of temp. rise	1 to 5	°C/sec
В	Heat time	50 to 150	sec
ь	Heat temperature	120 to 180	$^{\circ}\!\mathbb{C}$
С	Slope of temp. rise	1 to 5	°C/sec
D	Time over 230°C	90~120	sec
Е	Peak temperature	255~260	$^{\circ}\!\mathbb{C}$
E	Peak hold time	10 max.	sec
	No. of mounting	3	times

Time [sec] (Melting area of solder)

Reworking with soldering iron

Preheating	150°C, 1 minute
Tip temperature	280°C max.
Soldering time	3 seconds max.
Soldering iron output	30w max.
End of soldering iron	f3mm max.

Reworking should be limited to only one time.

Note: Do not directly touch the products with the tip of the soldering iron in order to prevent the crack on the ferrite material due to the thermal shock.

Solder Volume

Solder shall be used not to be exceed the upper limits as shown below.

Upper Limit Recommendable

When solder volume is increased, the mechanical stress to product is also

increased. Exceeding solder volume may cause the failure of mechanical or electrical performance.

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Mechanical Characteristics

ITEM	CONDITION	SPECIFICATION
Flexure Strength	45 (1.772) 45 (1.772) 40 (1.575)	Change In Appearance Without distinct damage
Duran Tara	100 (3.937)	Change In Common Mode Impedance:
Drop Test	Components shall be dropped three times on a concrete or steel board at height of 1M naturally at any directions.	Within ± 20%
Vibration (Random)	Components shall be randomly vibrated at amplitude of 1.5mm and frequency of 10 - 55 Hz: 0.04 G / Hz, 1 minute at a	Insulation Resistance: $10 \mathrm{M}\Omega$ min
	period of 2 hours in each of the three mutually perpendicular directions.	Withstanding Voltage:
Resistance to Soldering He	Preheat components at 80 to 120°C for 1 minute. Dip components into flux and then into a melted solder bath at 260 ± 5°C for 5 ± 1 seconds. Then components are to be tested after 4-48 hours at room temperature.	No damaged
Solderability	Dip pads in flux and then in a solder bath at $240 \pm 5^{\circ}$ C for 5 seconds.	A minimum of 80% of the metalized area must be covered with new solder.
Component Adhesion (Push Test)	Components shall be reflow solder onto a P.C. Board ($240 \pm 5^{\circ}$ C for 20 seconds). Then a dynometer force gauge shall be applied to any side of the component.	Components must withstand a minimum force of 1 Kg without any failure of the termination to component attachment.

Electrical Characteristics

ITEM	CONDITION	SPECIFICATION
Common Mode Measuring Equipment : HP-4286A or equivalent.		Within ± 25%
Impedance (Zc)	Measuring Frequency: 100 ± 1MHz	
and Tolerance	Measuring Temperature : 25 ± 5 °C	
	(Refer to Measurement Diagram)	
Insulation Resistance	Measuring Voltage: Rated Voltage	10 megaohms minimum
	Measuring Time: 1 minute max.	
	(Refer to Measurement Diagram)	
Dielectric	Test Voltage: 2.5 times to Rated Voltage	No damage occurs when
Withstanding Voltage	Time: 1 to 5 seconds.	the test voltage is applied.
	Charge current: 1mA max.	
	(Refer to Measurement Diagram)	
Rated Current	Test Current : Rated Current	Temperature Rise : ≤15°C
	(Refer to Measurement Diagram)	
DC Resistance (RDC)	Measured with current of 100mA max.	Within Specified Tolerance.
	In case of doubt, measured by four	
	terminal method.	
	(Refer to Measurement Diagram)	

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Endurance Characteristics

ITEM	CONDITION	SPECIFICATION
Cold Temperature Storage	Components shall be stored at temperature	
	of -40 ± 2 °C for 1000 (+48 hours -0 hour).	Change In Appearance
	Then components shall be subjected to	Without distinct damage
	standard atmospheric conditions for	
	4-48 hours. After that, measurement	
	shall be made.	Common Mode
High Temperature Storage	Components shall be stored at temperature	Impedance: Within ± 20%
	$+85 \pm 2$ °C for 1000 (+48 hours -0 hour).	
	Then components shall be subjected to	
	standard atmospheric conditions for	Insulation Resistance:
	4-48 hours. After that, measurement	$10 \mathrm{M}\Omega$ min
	shall be made.	
Moisture Resistance	Components shall be stored in the chamber	
	at 40°C at 90-95% R. H. for 1000	Withstanding Voltage:
	(+48 hours -0 hour). Then components are	No damaged
	to be tested after 4-48 hours at room	
	temperature.	
Temperature Cycle	Each cycle shall consist of 30 minutes at	
	-40°C followed by 30 minutes at +85°C	
	with a 10-15 minutes maximum transition	
	time between temperature extremes.	
	Test duration is 100 cycles, then	
	components are to be tested after	
	4-48 hours at room temperature.	
High Temperature	Components shall be stored at temperature	
with Loaded	of $+85 \pm 2$ °C for 1000 (+48 hours -0 hour).	
(Rated Current)	with rated current applied.	
	Then components shall be subjected to	
	standard atmospheric conditions for	
	4-48 hour. After that, measurement	
	shall be made.	

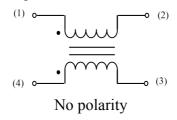
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Measurement Diagram

EQUIVALENT CIRCUIT



Terminal to be Tested

When measuring and supplying the voltage, the following terminal is applied.

No.	Item	Terminal to be Tested			
1	Common Mode Impedance (Measurement Terminal)	Terminal O Terminal			
2	Withstanding Voltage (Measurement Terminal)	Terminal O			
3	DC Resistance (Measurement Terminal)	Terminal O Terminal			
4	Rated Current	<u>}</u>			
5	Insulation Resistance	Terminal O			

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版次:第1.5版 MAX ECHO **Wirewound Common Mode Filter** COMPONENT SPECIFICATION 7 / Name EOWS-201212 SPEC# EOWS201212M900 **Paper Carrier Type Packing** 10-1 DIMENSIONS Unreeling direction DI B₀ P2 P₀ P1 Τ2 A0 D0 1.75 1.55 0.22 1.5 2.35 3.5 4.0 2.0 4.0 1.0 1.67 1.67 ±0.1 ±0.05 ±0.1 ±0.05 ±0.1 |±0.05| ±0.15 ±0.05 ±0.1 ±0.1 ±0.1 ±0.1 ±0.25 10-2 LEADER AND TRAILER TAPE Trailer Components Empty compar tments Leader End Start 20 pitch of more 110mm of more H.W 400. 560mm 10-3 DIRECTION THE DIRECTION SHALL BE SEEN FROM THE TOP OF COVER TAPE Jnreeling direction 10-4 REELS UNIT:mm 2±0.5 178 ±2.0 13.0±0.5 50 MIN 10 ±1.5 20 MAX PACKING QTY. 2,000 PCS REEL

COMPONENT SPECIFICATION

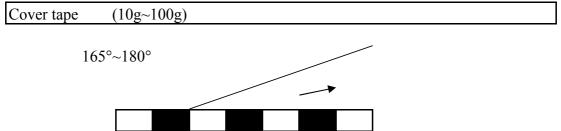
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PEELING STRENGTH OF COVER TAPE



Test condition

1. peel angle: 165°~180° vs carrier tape

2. peel speed: 300mm/min

Packaging

1.) Tape & Reel packaging in component specification 6/8

2) Reel and a bag of desiccant shall be packed in Nylon or plastic bag

3) Maximum of 5 reels shall be packaged in a inner box

4) Maximum of 6 inner box shall be packaged in a outer box

Reel Label

Producing the goods label needs to indicate (1) Pb Free (2) RoHS Compliant

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Storage

- 1. The solderability of the external electrode may be deteriorated if packages are stored where they are exposed to high humidity. Packages must be stored at 40°C or less and 70% RH or less.
- The solderability of the external electrode may be deteriorated if packages are stored where they are exposed to dust or harmful gas (hydrogen chloride, sulfurous acid gas or hydrogen sulfide).
- 3. Packaging material may be deformed if packages are stored where they are exposed to heat or direct sun—light.
- 4. Minimum packages, such as polyvinyl heat—seal packages shall not be opened until just before they are used. If opened, use the reels as soon as possible.
- 5. Solderability specified in component specification 4/8 shall be for 6 months from the date of delivery on condition that they are stored at the environment specified clause 13-1 & 13-2.

For those parts which passed more than 6 months shall be checked solderability before it is used.

Quality System

- ISO/IATF16949
- IECQ QC 080000